

BUX85G

SWITCHMODE NPN Silicon Power Transistors

The BUX85G is designed for high voltage, high speed power switching applications like converters, inverters, switching regulators, motor control systems.

Features

- $V_{CEO(sus)}$ – 450 V
- $V_{CES(sus)}$ – 1000 V
- Fall time = 0.3 μ s (typ) at $I_C = 1.0$ A
- $V_{CE(sat)}$ = 1.0 V (max) at $I_C = 1.0$ A, $I_B = 0.2$ A
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO(sus)}$	450	Vdc
Collector-Emitter Voltage	V_{CES}	1000	Vdc
Emitter-Base Voltage	V_{EBO}	5	Vdc
Collector Current – Continuous	I_C	2	Adc
– Peak (Note 1)	I_{CM}	3.0	
Base Current – Continuous	I_B	0.75	Adc
– Peak (Note 1)	I_{BM}	1.0	
Reverse Base Current – Peak	I_{BM}	1	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	50 400	W W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.5	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C}/\text{W}$
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 5 Seconds	T_L	275	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

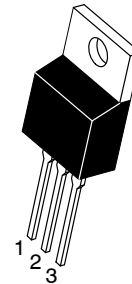
1. Pulse Test: Pulse Width = 5 ms, Duty Cycle \leq 10%.



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**2.0 AMPERES
POWER TRANSISTOR
NPN SILICON
450 VOLTS, 50 WATTS**



TO-220AB
CASE 221A-09
STYLE 1

MARKING DIAGRAM



BUX85 = Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
BUX85G	TO-220 (Pb-Free)	50 Units / Rail

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

BUX85G

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS (Note 2)

Collector–Emitter Sustaining Voltage ($I_C = 100\text{ mA}$, $L = 25\text{ mH}$) See Figure 1	$V_{CEO(sus)}$	450	–	–	Vdc
Collector Cutoff Current ($V_{CES} = \text{Rated Value}$) ($V_{CES} = \text{Rated Value}$, $T_C = 125^\circ\text{C}$)	I_{CES}	–	–	0.2 1.5	mAdc
Emitter Cutoff Current ($V_{EB} = 5\text{ Vdc}$, $I_C = 0$)	I_{EBO}	–	–	1	mAdc

ON CHARACTERISTICS (Note 2)

DC Current Gain ($I_C = 0.1\text{ Adc}$, $V_{CE} = 5\text{ V}$)	h_{FE}	30	50	–	–
Collector–Emitter Saturation Voltage ($I_C = 0.3\text{ Adc}$, $I_B = 30\text{ mAdc}$) ($I_C = 1\text{ Adc}$, $I_B = 200\text{ mAdc}$)	$V_{CE(sat)}$	–	–	0.8 1	Vdc
Base–Emitter Saturation Voltage ($I_C = 1\text{ Adc}$, $I_B = 0.2\text{ Adc}$)	$V_{BE(sat)}$	–	–	1.1	Vdc

DYNAMIC CHARACTERISTICS

Current–Gain – Bandwidth Product ($I_C = 500\text{ mAdc}$, $V_{CE} = 1.0\text{ Vdc}$, $f = 1\text{ MHz}$)	f_T	4	–	–	MHz
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SWITCHING CHARACTERISTICS

Turn-on Time	$V_{CC} = 250\text{ Vdc}$, $I_C = 1\text{ A}$ $I_{B1} = 0.2\text{ A}$, $I_{B2} = 0.4\text{ A}$ See Figure 2	t_{on}	–	0.3	0.5	μs
Storage Time		t_s	–	2	3.5	μs
Fall Time		t_f	–	0.3	–	μs
Fall Time		Same above cond. at $T_C = 95^\circ\text{C}$	t_f	–	–	1.4

2. Pulse Test: PW = 300 μs , Duty Cycle $\leq 2\%$.

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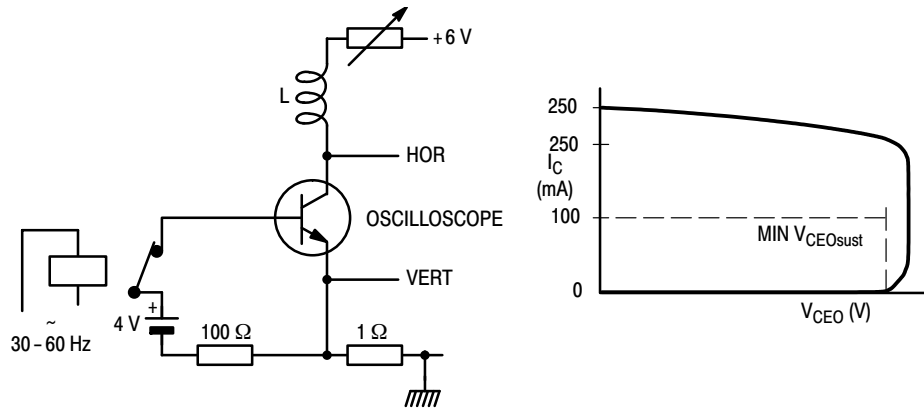


Figure 1. Test Circuit for $V_{CEOsust}$

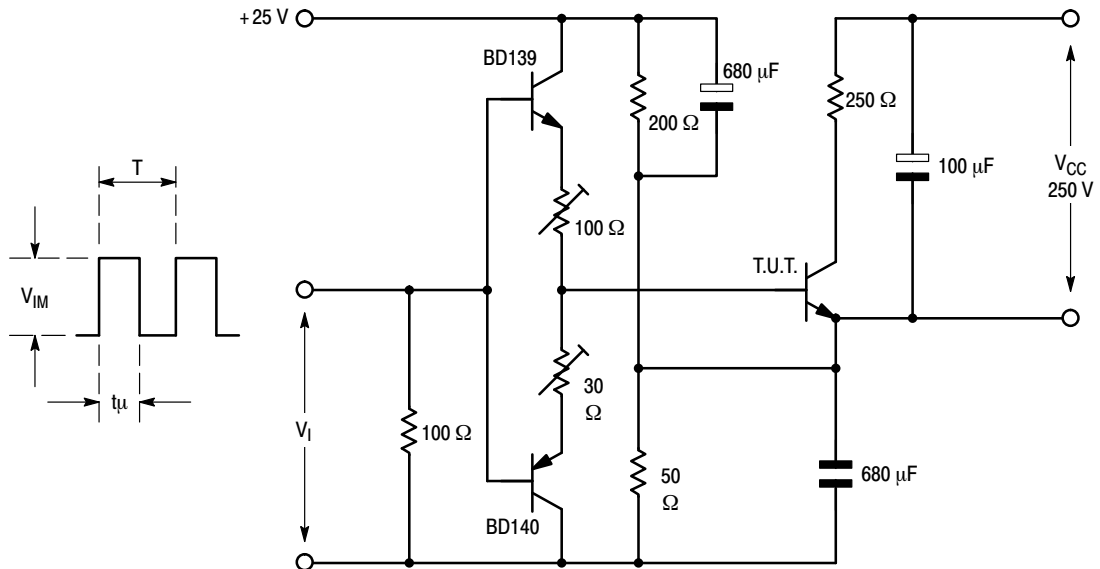
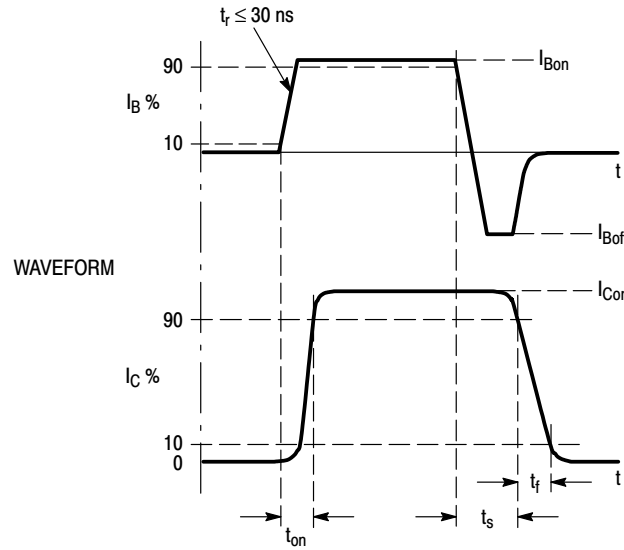
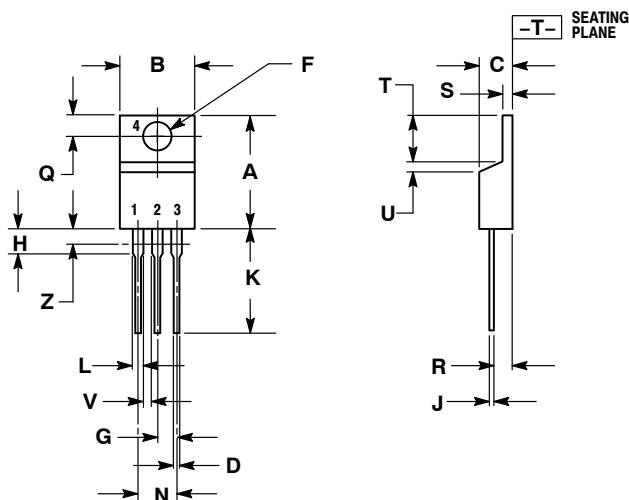


Figure 2. Switching Times/Test Circuit

BUX85G

PACKAGE DIMENSIONS


TO-220
CASE 221A-09
ISSUE AG



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.036	0.64	0.91
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
H	0.110	0.161	2.80	4.10
J	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

- STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

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